

Using the TPS51218EVM-496 High-Performance, Single Synchronous, Step–Down Controller for High-Current, Eco-mode™ Applications

The TPS51218EVM evaluation module (EVM) is used to evaluate the TPS51218, a small-size, single buck controller with adaptive on-time D-CAP[™] mode, providing a fixed 1.2-V output at up to 20 A from a 12-V input bus.

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1 Description

The TPS51218EVM is designed to use a regulated 12-V bus to produce a regulated 1.2-V output at up to 20 A of load current. The TPS51218EVM is designed to demonstrate the TPS51218 in a typical, low-voltage application while providing a number of test points to evaluate the performance of the TPS51218.

1.1 Typical Applications

- High-current system converters for server and desktop power
- Switchers and routers
- Embedded computers
- In-vehicle infotainment PCs
- POS terminals
- Point-of-load modules
- · Graphics cards
- Industrial control/factory automation PCs

1.2 Features

The TPS51218EVM features:

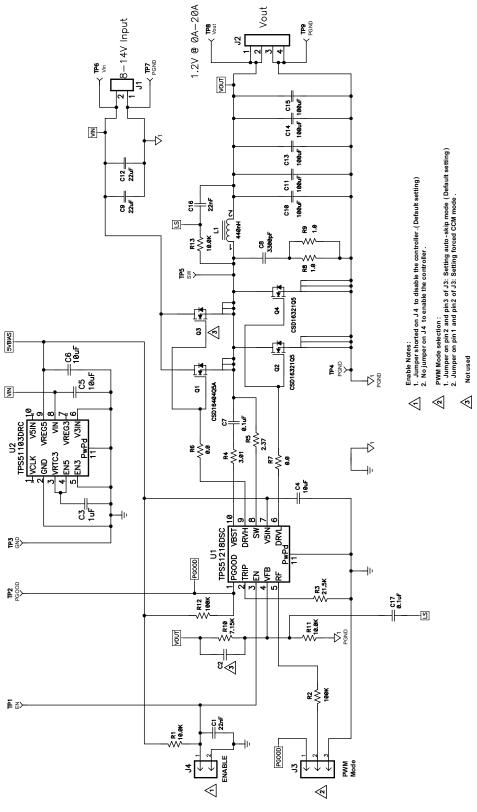
- 20-Adc steady-state current
- Support prebias output voltage start-up
- 380-kHz switching frequency
- J4 for enable function
- J3 for auto-skip and forced CCM selection
- · Convenient test points for probing critical waveforms

2 Electrical Performance Specifications

Table 1. TPS51218EVM Electrical Performance Specifications

| Parameter | Test Conditions | Min | Тур | Max | Units |
|---------------------------|---|-----|--------|------|-------|
| INPUT CHARACTERISTICS | I | -11 | | | |
| Voltage range | VIN | 8 | 12 | 14 | V |
| Maximum input current | VIN = 8 V, Io = 20 A | | | 3.55 | А |
| No load input current | Vin = 14 V, Io = 0 A | | | 50 | mA |
| OUTPUT CHARACTERISTICS | 1 | | | 1 | |
| Output voltage VOUT | | | 1.2 | | V |
| | Line regulation (Vin = 10 V-14 V) | | 1.0% | | |
| Output voltage regulation | Load regulation (Vin = 12 V, Io = 0 A–20 A) | | 1.0% | | |
| Output voltage ripple | Vin = 12 V, Io = 20 A | | | 40 | mVpp |
| Output load current | | 0 | | 20 | А |
| Output overcurrent | | | 30 | | А |
| SYSTEMS CHARACTERISTICS | · · | | | | |
| Switching frequency | | | 380 | | kHz |
| Peak efficiency | Vin = 12 V, 1.2 V/10 A | | 90.32% | | |
| Full-load efficiency | Vin = 12 V, 1.2 V/20 A | | 88.64% | | |
| Operating temperature | | | 25 | | °C |

3 Schematic







4 Test Setup

4.1 Test Equipment

Voltage Source: The input voltage source Vin must be a 0-V to 14-V variable dc source capable of supplying 10 Adc. Connect Vin to J1 as shown in Figure 3.

Multimeters: A 0-V to 15-V voltmeter must be used to measure Vin at TP6 (Vin) and TP7 (PGND) and a 0-V to 5-V voltmeter for Vout measurement at TP8 (Vout) and TP9 (PGND). A 0-A to 10-A current meter (A1) as shown in Figure 3 is used for input current measurements.

Output Load: The output load must be an electronic constant resistance mode load capable of 0 Adc to 30 Adc at 1.2 V.

Oscilloscope: A digital or analog oscilloscope can be used to measure the output ripple. The oscilloscope must be set for $1-M\Omega$ impedance, 20-MHz bandwidth, ac coupling, $2-\mu$ s/division horizontal resolution, 50-mV/division vertical resolution. Test points TP8 and TP9 can be used to measure the output ripple voltage by placing the oscilloscope probe tip through TP8 and holding the ground barrel TP9 as shown in Figure 2. Using a leaded ground connection may induce additional noise due to the large ground loop.

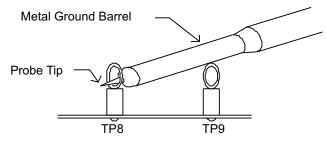


Figure 2. Tip and Barrel Measurement for Vout Ripple

Fan: Some of the components in this EVM may get hot, approaching temperatures up to 60°C during operation. A small fan capable of 200 to 400 LFM is recommended to reduce component temperatures while the EVM is operating. The EVM must not be probed while the fan is not running.

Recommended Wire Gauge: For VIN to J1 (12-V input) the recommended wire size is 1x AWG 14 per input connection, with the total length of wire less than 4 feet (2-foot input, 2-foot return). For J2 to LOAD, the minimum recommended wire size is 2x AWG 14, with the total length of wire less than 4 feet (2-foot output, 2-foot return).



Test Setup

4.2 Recommended Test Setup

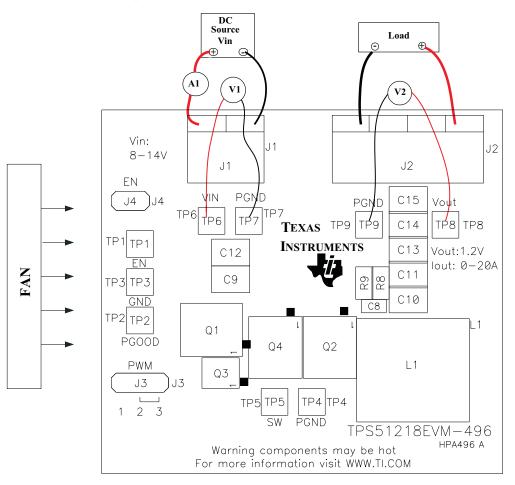


Figure 3. TPS51218EVM Recommended Test Setup

Figure 3 shows the recommended test setup to evaluate the TPS51218EVM. Working at an ESD workstation, ensure that any wrist straps, bootstraps, or mats are connected referencing the user to earth ground before power is applied to the EVM.

4.2.1 Configurations

- 1. EN J4 setting
 - (a) No jumper enables the controller.
 - (b) A jumper shorted on J4 disables the controller (default setting).
- 2. PWM J3 setting
 - (a) A jumper on pin 2 and pin 3 of J3 set the auto-skip mode (default setting).
 - (b) A jumper on pin 1 and pin 2 of J3 sets a forced CCM mode.

4.2.2 Input Connections

- 1. Prior to connecting the dc input source Vin, it is advisable to limit the source current from Vin to 10 A maximum. Ensure that Vin is initially set to 0 V and connected as shown in Figure 3.
- 2. Connect a voltmeter V1 at TP6 (Vin) and TP7 (PGND) to measure the input voltage.
- 3. Connect a current meter A1 to measure the input current.

4.2.3 Output Connections

6

1. Connect the load to J2, and set the load to constant resistance mode to sink 0 Adc before Vin is



applied.

2. Connect a voltmeter V2 at TP8 (Vout) and TP9 (PGND) to measure the output voltage.

4.2.4 Other Connections

Place a fan as shown in Figure 3 and turn it on, making sure that air is flowing across the EVM.

5 Test Procedure

5.1 Line/Load Regulation and Efficiency Measurement Procedure

- 1. Ensure that the load is set to constant resistance mode and to sink 0 Adc.
- 2. Ensure that the jumper provided in the EVM to short J4 is on before Vin is applied.
- 3. Ensure that the jumper provided in the EVM to short pin 2 and pin 3 of J3 is on before Vin is applied.
- 4. Increase Vin from 0 V to 12 V. Use V1 to measure the input voltage.
- 5. Remove the jumper on J4 to enable the controller.
- 6. Vary the load from 0 Adc to 20 Adc. Vout must remain in load regulation.
- 7. Vary Vin from 8 V to 14 V. Vout must remain in line regulation.
- 8. Put the jumper on J4 to disable the controller.
- 9. Decrease the load to 0 A.
- 10. Decrease Vin to 0 V.

5.2 List of Test Points

| Test Points | Name | Description |
|-------------|-------|----------------|
| TP1 | EN | Enable |
| TP2 | PGOOD | Power Good |
| TP3 | GND | GND |
| TP4 | PGND | PGND |
| TP5 | SW | Switching node |
| TP6 | Vin | Vin |
| TP7 | PGND | GND for Vin |
| TP8 | Vout | Vout |
| TP9 | PGND | PGND |

Table 2. The Functions of Each Test Points

5.3 Equipment Shutdown

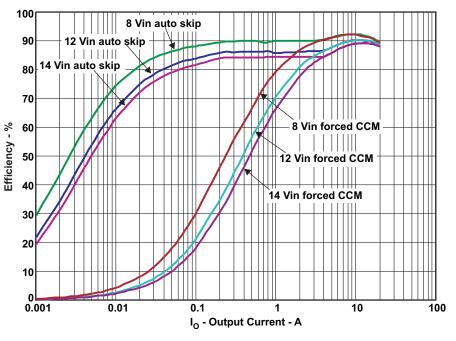
- 1. Shut down the load.
- 2. Shut down Vin.
- 3. Shut down the fan.

6 Performance Data and Typical Characteristic Curves

Figure 4 through Figure 12 present typical performance curves for the TPS51218EVM.

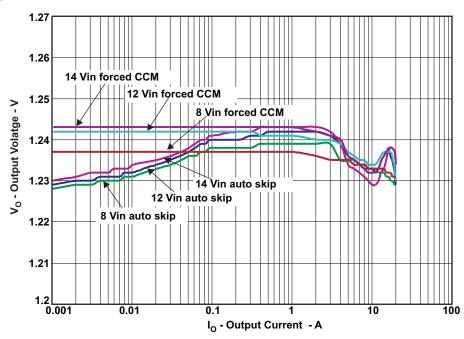


6.1 Efficiency





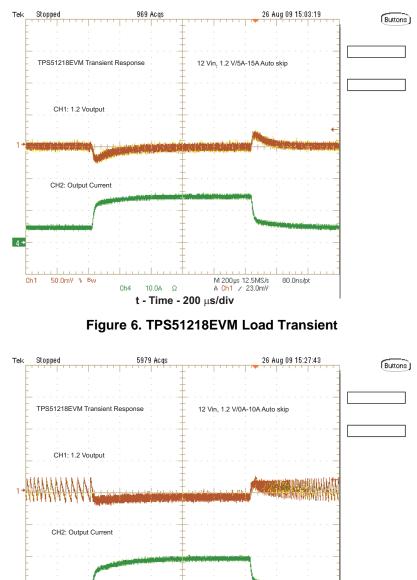
6.2 Load Regulation







6.3 Transient Response







Ch1



6.4 Output Ripple

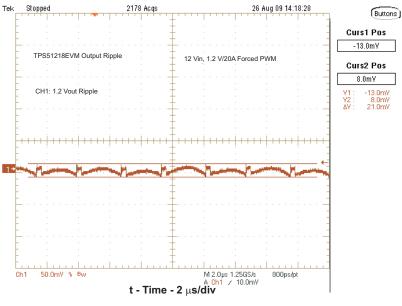
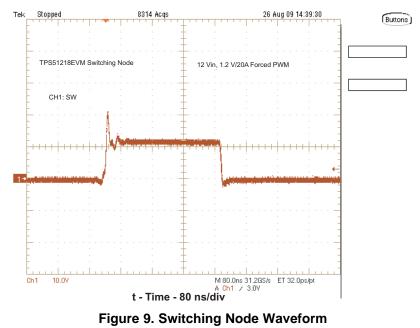


Figure 8. Output Ripple

6.5 Switch Node Voltage





6.6 Turnon Waveform

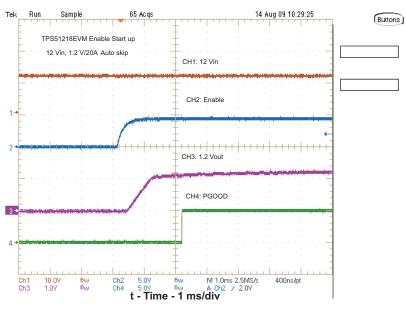


Figure 10. Enable Turnon Waveform

6.7 Turnoff Waveform

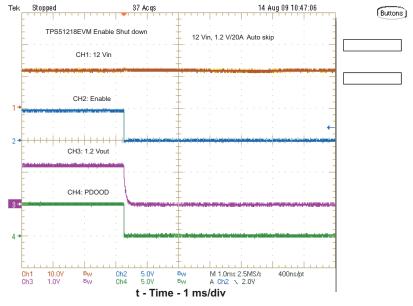


Figure 11. Enable Turnoff Waveform



6.8 Output 1.1-V Prebias Turnon

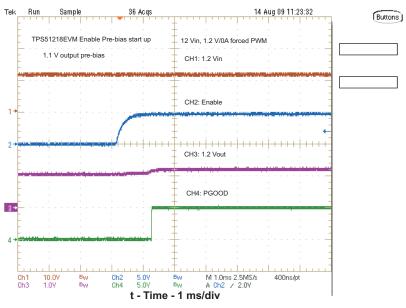


Figure 12. Output 1.1V Prebias Turnon

7 EVM Assembly Drawing and PCB Layout

Figure 13 through Figure 18 show the design of the TPS51218EVM printed-circuit board. The EVM has been designed using a four-layer, 2-oz copper circuit board.

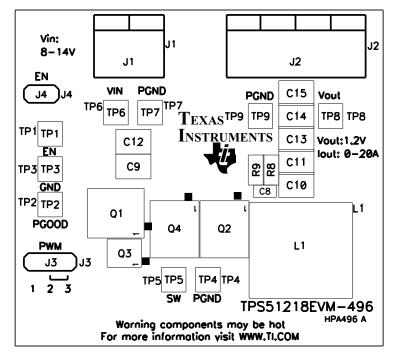


Figure 13. TPS51218EVM Top Layer Assembly Drawing, Top View



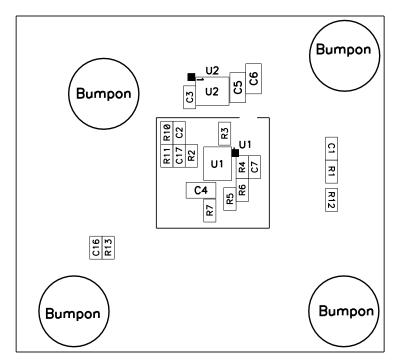


Figure 14. TPS51218EVM Bottom Assembly Drawing, Bottom View

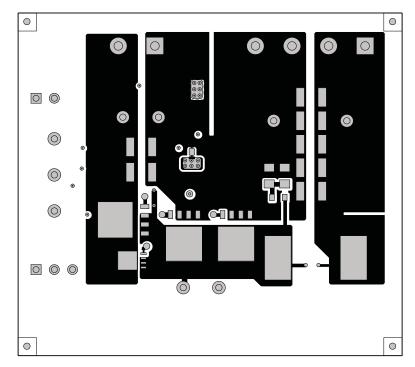


Figure 15. TPS51218EVM Top Copper, Top View



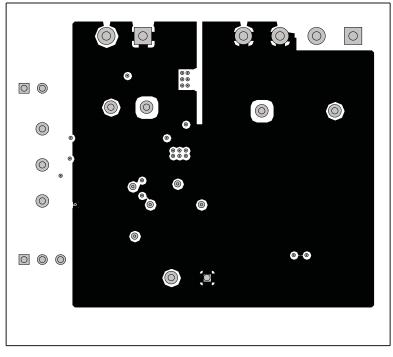


Figure 16. TPS51218EVM Internal Layer 1

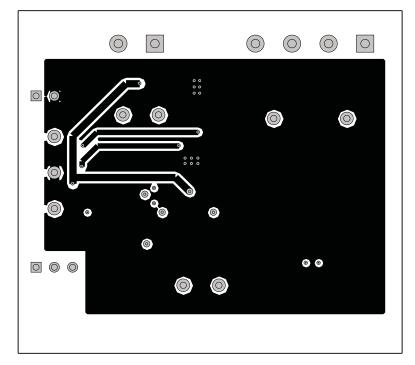


Figure 17. TPS51218EVM Internal Layer 2



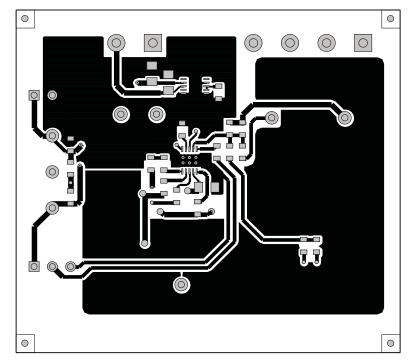


Figure 18. TPS51218EVM Bottom Layer

8 **Bill of Materials**

The EVM components are shown in Table 3 according to the schematic shown in Figure 1.

Table 3. Bill of Materials

| QTY | REFDES | Description | MFR | Part Number |
|-----|----------------------------|--|--------------|--------------------|
| 2 | C9, C12 | Capacitor, Ceramic, 22 µF, 16V, X5R, 10%, 1210 | Murata | GRM32ER61C226KE20L |
| 1 | C3 | Capacitor, Ceramic, 1 µF, 16V, X7R, 10%, 0603 | STD | STD |
| 2 | C1, C16 | Capacitor, Ceramic, 0.022 µF, 16V, X7R, 10%, 0603 | STD | STD |
| 1 | C8 | Capacitor, Ceramic, 3300 pF, 25V, X7R, 10%, 0603 | STD | STD |
| 3 | C4, C5, C6 | Capacitor, Ceramic, 10 µF, 16V, X5R, 10%, 0805 | STD | STD |
| 2 | C7, C17 | Capacitor, Ceramic, 0.1 µF, 25V, X7R, 10%, 0603 | STD | STD |
| 5 | C10, C11, C13, C14, C15 | Capacitor, Ceramic, 100 µF, 6.3V, X5R, 20%, 1210 | Murata | GRM32ER60J107ME20L |
| 1 | L1 | Inductor, SMT, 0.44 μH, 30A, 0.0032 Ω, 0.530" x 0.510" | Pulse | PA0513.441NLT |
| | | | E&E Magnetic | 831-02990F |
| 1 | Q1 | MOSFET, Nchan, 25V, 21A, 4.1 mΩ, QFN5X6mm | TI (Ciclon) | CSD16404Q5A |
| 2 | Q2, Q4 | MOSFET, Nchan, 25V, 31A, 2.1 mΩ, QFN5X6mm | TI(Ciclon) | CSD16321Q5 |
| 3 | R1, R11, R13 | Resistor, Chip, 10K, 1/16W, 1%, 0603 | STD | STD |
| 1 | R10 | Resistor, Chip, 7.15K, 1/16W, 1%, 0603 | STD | STD |
| 1 | R3 | Resistor, Chip, 19.6K, 1/16W, 1%, 0603 | STD | STD |
| 2 | R2, R12 | Resistor, Chip, 100K, 1/16W, 1%, 0603 | STD | STD |
| 2 | R6, R7 | Resistor, Chip, 0, 1/16W, 1%, 0603 | STD | STD |
| 1 | R4 | Resistor, Chip, 3.01, 1/16W, 1%, 0603 | | |
| 1 | R5 | Resistor, Chip, 2.37, 1/16W, 1%, 0603 | STD | STD |
| 2 | R8, R9 | Resistor, Chip, 1, 1/16W, 5%, 0805 | STD | STD |
| 1 | U2 | IC, Integrated LDO with switch-over circuit, DGS10 | ТІ | TPS51103DRC |
| 1 | U1 | IC, Synchronous step down controller, DSC10 | ТІ | TPS51218DSC |

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EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 8 V to 14 V and the output voltage range of 1 V to 1.4 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 60° C. The EVM is designed to operate properly with certain components above 60° C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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